- **8-Bit Voltage Output DAC**
- **Programmable Settling Time vs Power Consumption**
    - **3 μs in Fast Mode**
    - **9 μs in Slow Mode**
- **Ultra Low Power Consumption:**
    - **900 μW Typ in Slow Mode at 3 V**
    - **2.1 mW Typ in Fast Mode at 3 V**
- **Differential Nonlinearity . . . <0.2 LSB**
- **Compatible With TMS320 and SPI Serial Ports**
- **Power-Down Mode**

- **Buffered High-Impedance Reference Input**
- **Monotonic Over Temperature**
- **Available in MSOP Package**

applications

- **Digital Servo Control Loops**
- **Digital Offset and Gain Adjustment**
- **Industrial Process Control**
- **Machine and Motion Control Devices**
- **Mass Storage Devices**

description

D OR DGK PACKAGE
(TOP VIEW)

|		
DIN	1	8	V_{DD}
SCLK	2	7	OUT
$\overline{CS}$	3	6	REFIN
FS	4	5	AGND

The TLV5623 is a 8-bit voltage output digital-to-analog converter (DAC) with a flexible 4-wire serial interface. The 4-wire serial interface allows glueless interface to TMS320, SPI, QSPI, and Microwire serial ports. The TLV5623 is pro-grammed with a 16-bit serial string containing 4 control and 8 data bits. Developed for a wide range of supply voltages, the TLV5623 can operate from 2.7 V to 5.5 V.

The resistor string output voltage is buffered by a x2 gain rail-to-rail output buffer. The buffer features a Class AB output stage to improve stability and reduce settling time. The settling time of the DAC is programmable to allow the designer to optimize speed versus power dissipation. The settling time is chosen by the control bits within the 16-bit serial input string. A high-impedance buffer is integrated on the REFIN terminal to reduce the need for a low source impedance drive to the terminal.

Implemented with a CMOS process, the TLV5623 is designed for single supply operation from 2.7 V to 5.5 V. The device is available in an 8-terminal SOIC package. The TLV5623C is characterized for operation from 0°C to 70°C. The TLV5623I is characterized for operation from −40°C to 85°C.
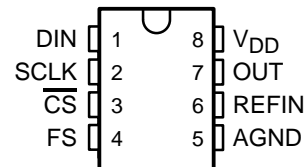
AVAILABLE OPTIONS

	PACKAGE	
T_A	SMALL OUTLINE† (D)	MSOP (DGK)
0°C to 70°C	TLV5623CD	TLV5623CDGK
−40°C to 85°C	TLV5623ID	TLV5623IDGK

† Available in tape and reel as the TLV5623CDR and the TLV5623IDR

Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

TEXAS INSTRUMENTS

functional block diagram
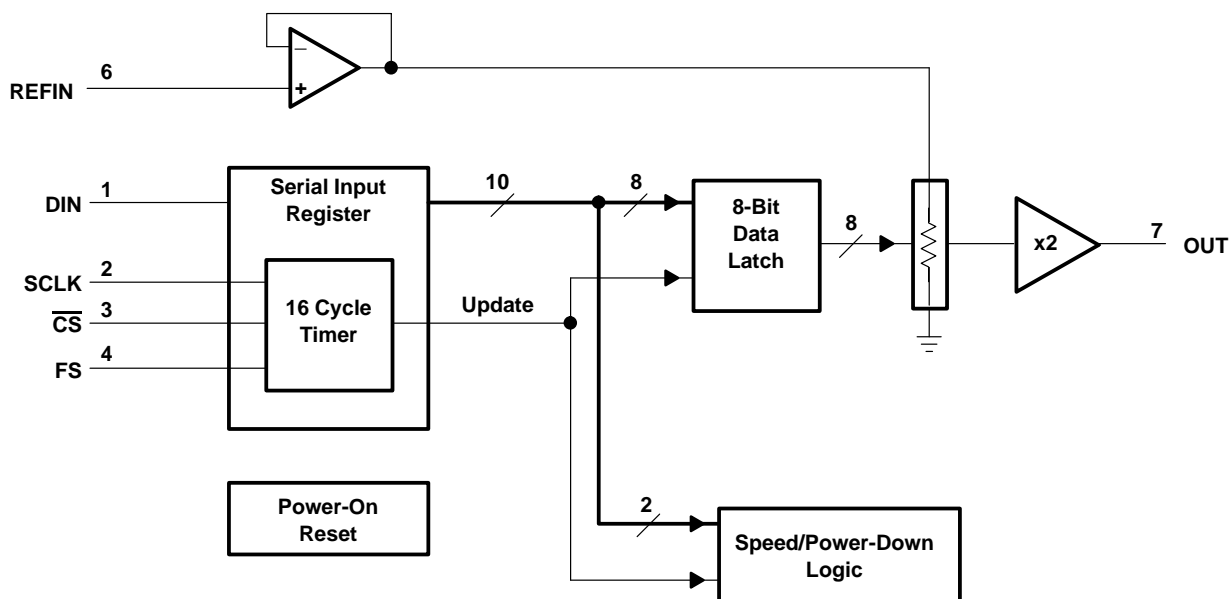
Terminal Functions

TERMINAL		I/O	DESCRIPTION
NAME	NO.		
AGND	5		Analog ground
$\overline{CS}$	3	I	Chip select. Digital input used to enable and disable inputs, active low.
DIN	1	I	Serial digital data input
FS	4	I	Frame sync. Digital input used for 4-wire serial interfaces such as the TMS320 DSP interface.
OUT	7	O	DAC analog output
REFIN	6	I	Reference analog input voltage
SCLK	2	I	Serial digital clock input
V_{DD}	8		Positive power supply

**TEXAS
INSTRUMENTS**
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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage (V_{DD} to AGND)	7 V
Reference input voltage range	-0.3 V to $V_{DD} + 0.3$ V
Digital input voltage range	-0.3 V to $V_{DD} + 0.3$ V
Operating free-air temperature range, T_A: TLV5623C	0°C to 70°C
TLV5623I	-40°C to 85°C
Storage temperature range, T_{stg}	-65°C to 150°C
Lead temperature 1,6 mm (1/16 inch) from case for 10 seconds	260°C

† Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

recommended operating conditions

		MIN	NOM	MAX	UNIT
Supply voltage, V_{DD}	$V_{DD} = 5$ V	4.5	5	5.5	V
	$V_{DD} = 3$ V	2.7	3	3.3	V
High-level digital input voltage, V_{IH}	$DV_{DD} = 2.7$ V	2			V
	$DV_{DD} = 5.5$ V	2.4			V
Low-level digital input voltage, V_{IL}	$DV_{DD} = 2.7$ V			0.6	V
	$DV_{DD} = 5.5$ V			1	V
Reference voltage, V_{ref} to REFIN terminal	$V_{DD} = 5$ V (see Note 1)	AGND	2.048	$V_{DD} - 1.5$	V
Reference voltage, V_{ref} to REFIN terminal	$V_{DD} = 3$ V (see Note 1)	AGND	1.024	$V_{DD} - 1.5$	V
Load resistance, R_L		2	10		kΩ
Load capacitance, C_L				100	pF
Clock frequency, f_{CLK}				20	MHz
Operating free-air temperature, T_A	TLV5623C	0		70	°C
	TLV5623I	-40		85	°C

NOTE 1: Due to the x2 output buffer, a reference input voltage $\geq V_{DD}/2$ causes clipping of the transfer function.

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

power supply

PARAMETER		TEST CONDITIONS		MIN	TYP	MAX	UNIT
I_{DD} Power supply current		$V_{DD} = 5$ V, VREF = 2.048 V, No load, All inputs = AGND or V_{DD}, DAC latch = 0x800	Fast		0.9	1.35	mA
			Slow		0.4	0.6	mA
		$V_{DD} = 3$ V, VREF = 1.024 V No load, All inputs = AGND or V_{DD}, DAC latch = 0x800	Fast		0.7	1.1	mA
			Slow		0.3	0.45	mA
Power down supply current (see Figure 12)						1	µA
PSRR Power supply rejection ratio	Zero scale	See Note 2			-68		dB
	Full scale	See Note 3			-68		
Power on threshold voltage, POR						2	V

NOTES: 2. Power supply rejection ratio at zero scale is measured by varying V_{DD} and is given by:
   PSRR = 20 log [($E_{ZS}(V_{DD}max) - E_{ZS}(V_{DD}min))/V_{DD}max$]
   3. Power supply rejection ratio at full scale is measured by varying V_{DD} and is given by:
   PSRR = 20 log [($E_G(V_{DD}max) - E_G(V_{DD}min))/V_{DD}max$]

TEXAS
INSTRUMENTS

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted) (continued)

static DAC specifications R_L = 10 kΩ, C_L = 100 pF

	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
	Resolution			8		bits
INL	Integral nonlinearity	See Note 4		± 0.3	±0.5	LSB
DNL	Differential nonlinearity	See Note 5		± 0.07	± 0.2	LSB
E_{ZS}	Zero-scale error (offset error at zero scale)	See Note 6			±10	mV
$E_{ZS\ TC}$	Zero-scale-error temperature coefficient	See Note 7		10		ppm/°C
E_G	Gain error	See Note 8			±0.6	% of FS voltage
	Gain-error temperature coefficient	See Note 9		10		ppm/°C

NOTES: 4. The relative accuracy or integral nonlinearity (INL) sometimes referred to as linearity error, is the maximum deviation of the output from the line between zero and full scale excluding the effects of zero code and full-scale errors.

5. The differential nonlinearity (DNL) sometimes referred to as differential error, is the difference between the measured and ideal 1 LSB amplitude change of any two adjacent codes. Monotonic means the output voltage changes in the same direction (or remains constant) as a change in the digital input code.

6. Zero-scale error is the deviation from zero voltage output when the digital input code is zero.

7. Zero-scale-error temperature coefficient is given by: $E_{ZS\ TC} = [E_{ZS}\ (T_{max}) - E_{ZS}\ (T_{min})]/V_{ref} \times 10^6/(T_{max} - T_{min})$.

8. Gain error is the deviation from the ideal output ($2V_{ref} - 1$ LSB) with an output load of 10 kΩ excluding the effects of the zero-error.

9. Gain temperature coefficient is given by: $E_G\ TC = [E_G(T_{max}) - E_G\ (T_{min})]/V_{ref} \times 10^6/(T_{max} - T_{min})$.

output specifications

	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
V_O	Voltage output range	R_L = 10 kΩ	0		V_{DD}–0.1	V
	Output load regulation accuracy	R_L = 2 kΩ, vs 10 kΩ		±0.1	±0.25	% of FS voltage

reference input (REF)

	PARAMETER	TEST CONDITIONS		MIN	TYP	MAX	UNIT
V_I	Input voltage range			0		V_{DD}–1.5	V
R_I	Input resistance				10		MΩ
C_I	Input capacitance				5		pF
	Reference input bandwidth	REFIN = 0.2 V_{pp} + 1.024 V dc	Slow		525		kHz
			Fast		1.3		MHz
	Reference feed through	REFIN = 1 V_{pp} at 1 kHz + 1.024 V dc (see Note 10)			–75		dB

NOTE 10: Reference feedthrough is measured at the DAC output with an input code = 0x000.

digital inputs

	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
I_{IH}	High-level digital input current	$V_I = V_{DD}$			±1	μA
I_{IL}	Low-level digital input current	V_I = 0 V			±1	μA
C_I	Input capacitance				3	pF

TEXAS
INSTRUMENTS

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operating characteristics over recommended operating free-air temperature range (unless otherwise noted)

analog output dynamic performance

PARAMETER		TEST CONDITIONS			MIN	TYP	MAX	UNIT
$t_{s(FS)}$	Output settling time, full scale	$R_L = 10$ kΩ, See Note 11	$C_L = 100$ pF,	Fast		3	5.5	μs
				Slow		9	20	
$t_{s(CC)}$	Output settling time, code to code	$R_L = 10$ kΩ, See Note 12	$C_L = 100$ pF,	Fast		1		μs
				Slow		2		μs
SR	Slew rate	$R_L = 10$ kΩ, See Note 13	$C_L = 100$ pF,	Fast		3.6		V/μs
				Slow		0.9		
	Glitch energy	Code transition from 0x7F0 to 0x800				10		nV–s
S/N	Signal to noise	fs = 400 KSPS fout = 1.1 kHz, $R_L = 10$ kΩ, $C_L = 100$ pF, BW = 20 kHz				57		dB
S/(N+D)	Signal to noise + distortion					49		dB
THD	Total harmonic distortion					–50		dB
	Spurious free dynamic range					60		dB

NOTES: 11. Settling time is the time for the output signal to remain within ±0.5 LSB of the final measured value for a digital input code change of 0x020 to 0xFF0 or 0xFF0 to 0x020. Not tested, ensured by design.
12. Settling time is the time for the output signal to remain within ± 0.5 LSB of the final measured value for a digital input code change of one count. Not tested, ensured by design.
13. Slew rate determines the time it takes for a change of the DAC output from 10% to 90% full-scale voltage.

digital input timing requirements

		MIN	NOM	MAX	UNIT
$t_{su(CS–FS)}$	Setup time, $\overline{CS}$ low before FS↓	10			ns
$t_{su(FS–CK)}$	Setup time, FS low before first negative SCLK edge	8			ns
$t_{su(C16–FS)}$	Setup time, sixteenth negative edge after FS low on which bit D0 is sampled before rising edge of FS	10			ns
$t_{su(C16–CS)}$	Setup time, sixteenth positive SCLK edge (first positive after D0 is sampled) before $\overline{CS}$ rising edge. If FS is used instead of the sixteenth positive edge to update the DAC, then the setup time is between the FS rising edge and $\overline{CS}$ rising edge.	10			ns
t_{wH}	Pulse duration, SCLK high	25			ns
t_{wL}	Pulse duration, SCLK low	25			ns
$t_{su(D)}$	Setup time, data ready before SCLK falling edge	8			ns
$t_{h(D)}$	Hold time, data held valid after SCLK falling edge	5			ns
$t_{wH(FS)}$	Pulse duration, FS high	20			ns

PARAMETER MEASUREMENT INFORMATION

Figure 1. Timing Diagram

TYPICAL CHARACTERISTICS

OUTPUT VOLTAGE
vs
LOAD CURRENT

Figure 2

OUTPUT VOLTAGE
vs
LOAD CURRENT

Figure 3

OUTPUT VOLTAGE
vs
LOAD CURRENT

Figure 4

OUTPUT VOLTAGE
vs
LOAD CURRENT

Figure 5

TEXAS
INSTRUMENTS

TYPICAL CHARACTERISTICS

**SUPPLY CURRENT
vs
FREE-AIR TEMPERATURE**

Figure 6

**SUPPLY CURRENT
vs
FREE-AIR TEMPERATURE**

Figure 7

**TOTAL HARMONIC DISTORTION
vs
FREQUENCY**

Figure 8

**TOTAL HARMONIC DISTORTION
vs
FREQUENCY**
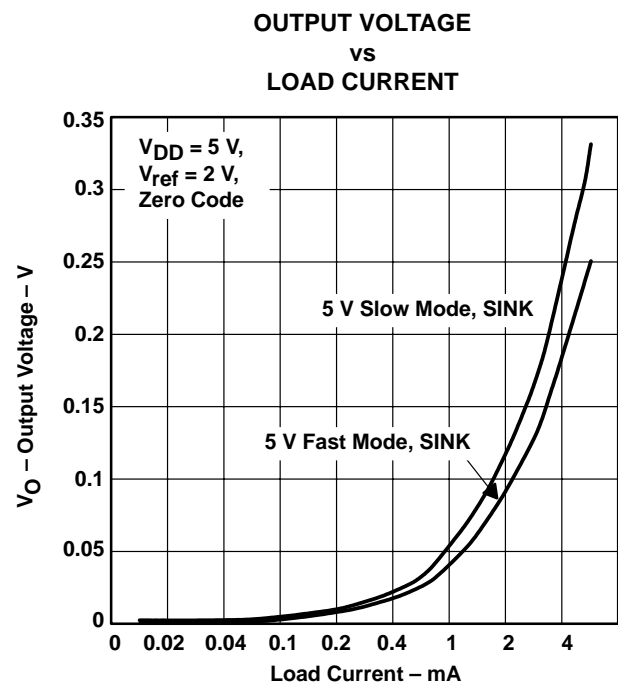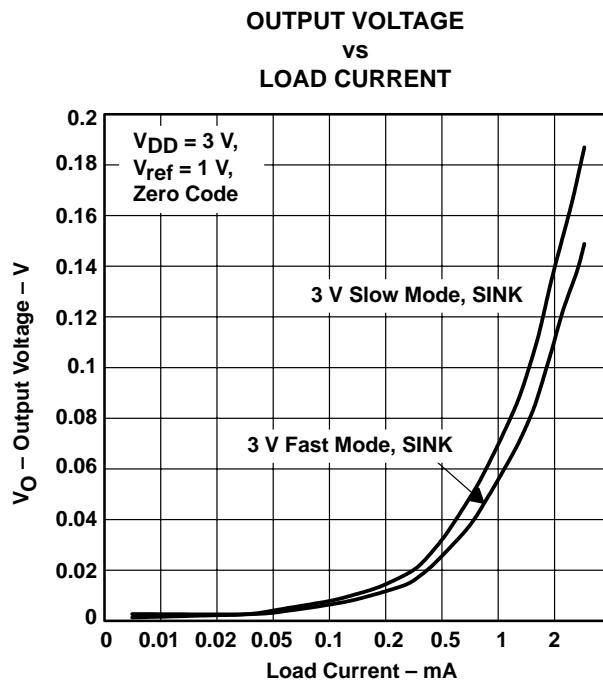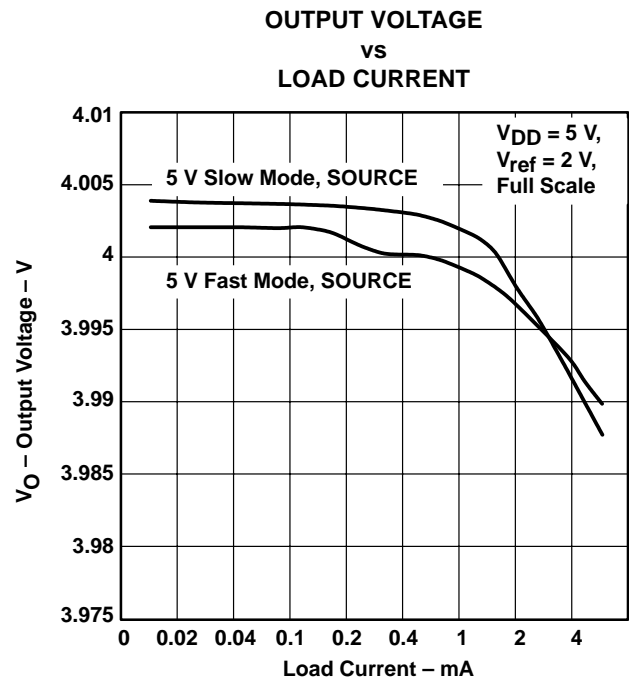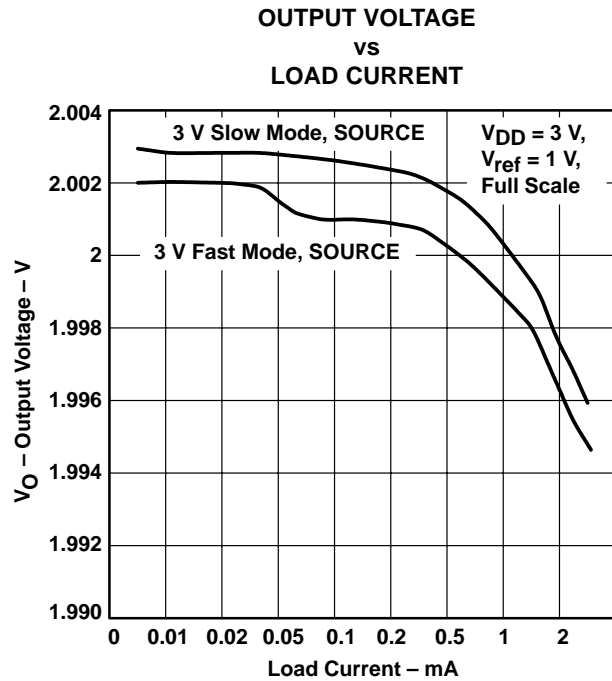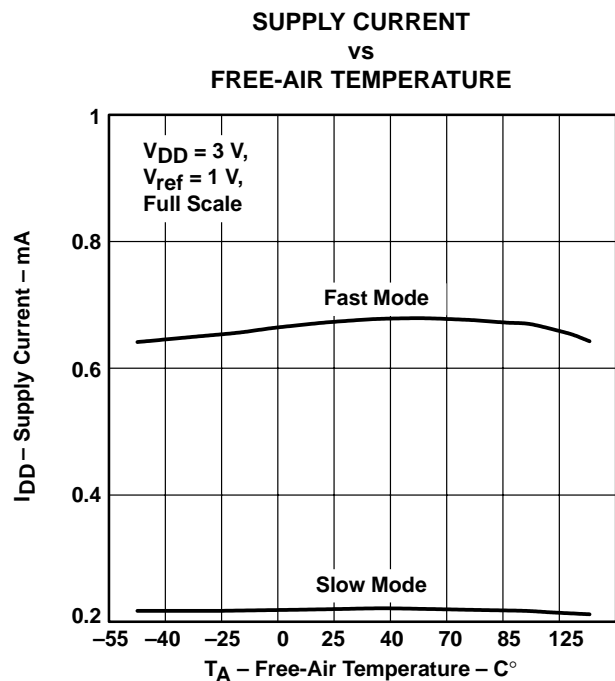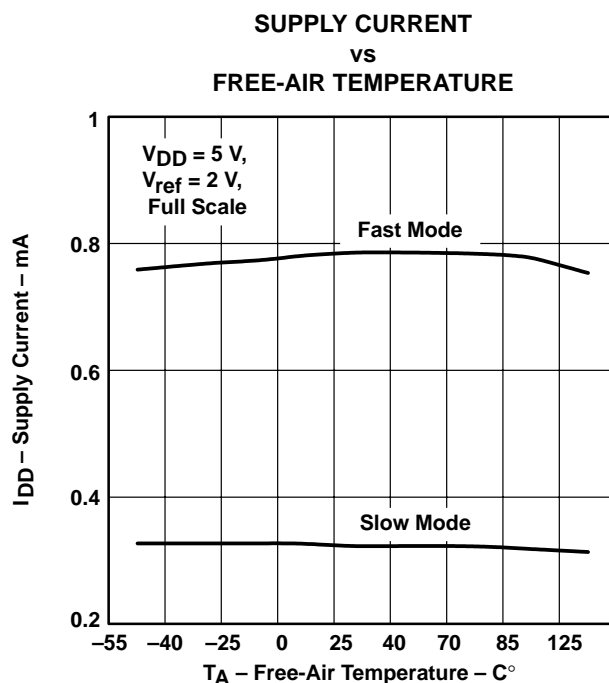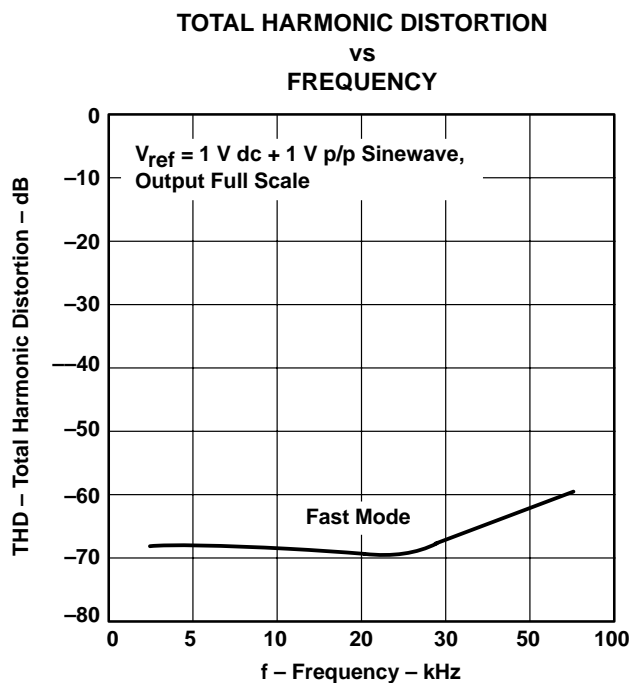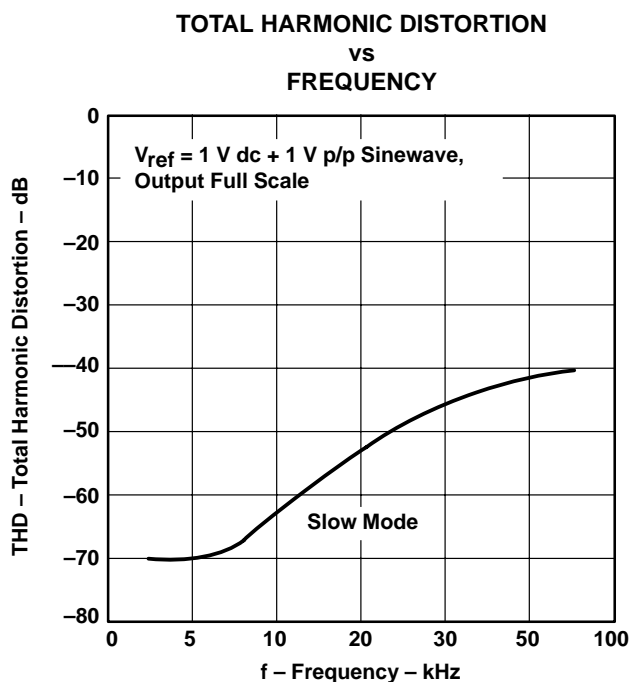
Figure 9

TYPICAL CHARACTERISTICS
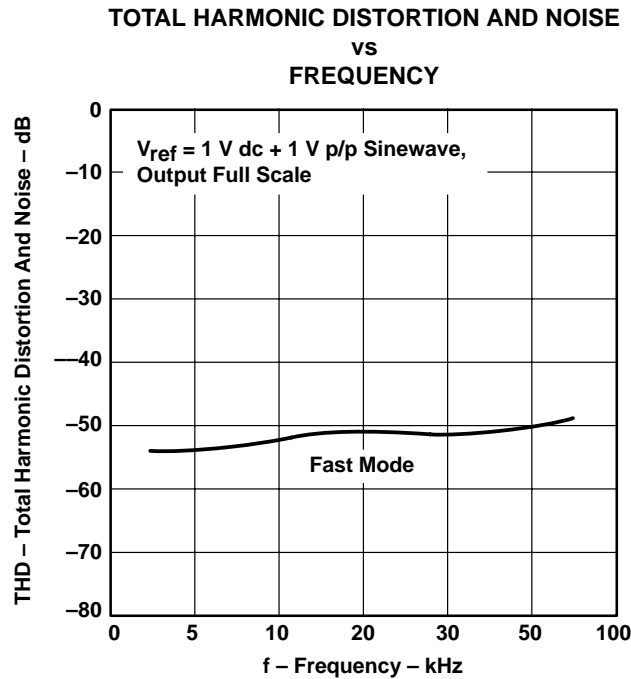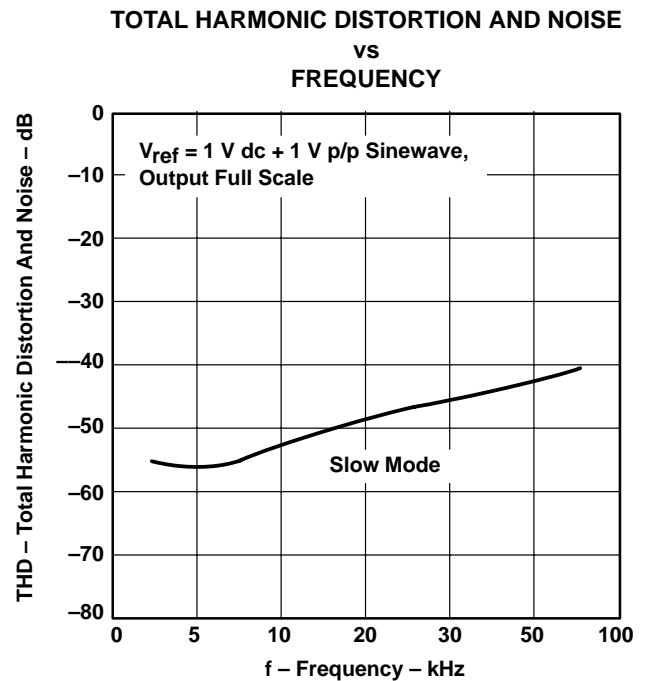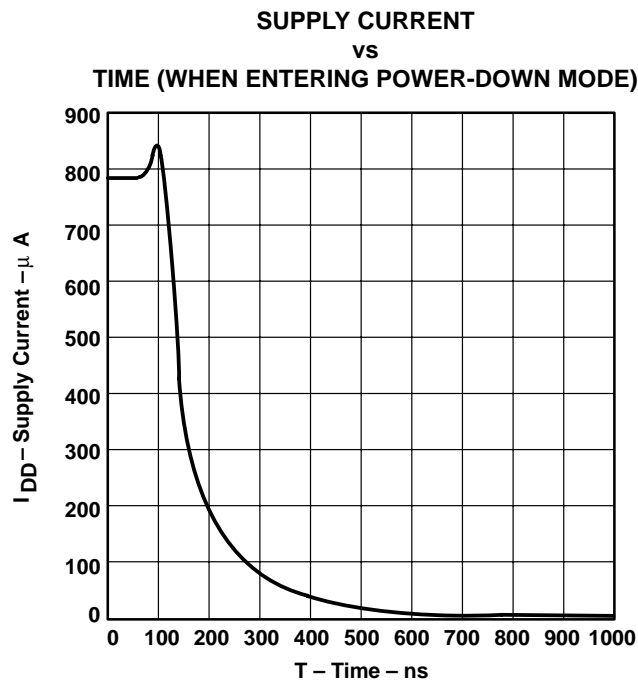
TOTAL HARMONIC DISTORTION AND NOISE
vs
FREQUENCY

$V_{ref} = 1$ V dc + 1 V p/p Sinewave,
Output Full Scale

Fast Mode

f – Frequency – kHz

Figure 10

TOTAL HARMONIC DISTORTION AND NOISE
vs
FREQUENCY

$V_{ref} = 1$ V dc + 1 V p/p Sinewave,
Output Full Scale

Slow Mode

f – Frequency – kHz

Figure 11

SUPPLY CURRENT
vs
TIME (WHEN ENTERING POWER-DOWN MODE)

T – Time – ns

Figure 12

![Texas Instruments logo]

TYPICAL CHARACTERISTICS

DIFFERENTIAL NONLINEARITY
vs
DIGITAL OUTPUT CODE

Figure 13

INTEGRAL NONLINEARITY
vs
DIGITAL OUTPUT CODE

Figure 14

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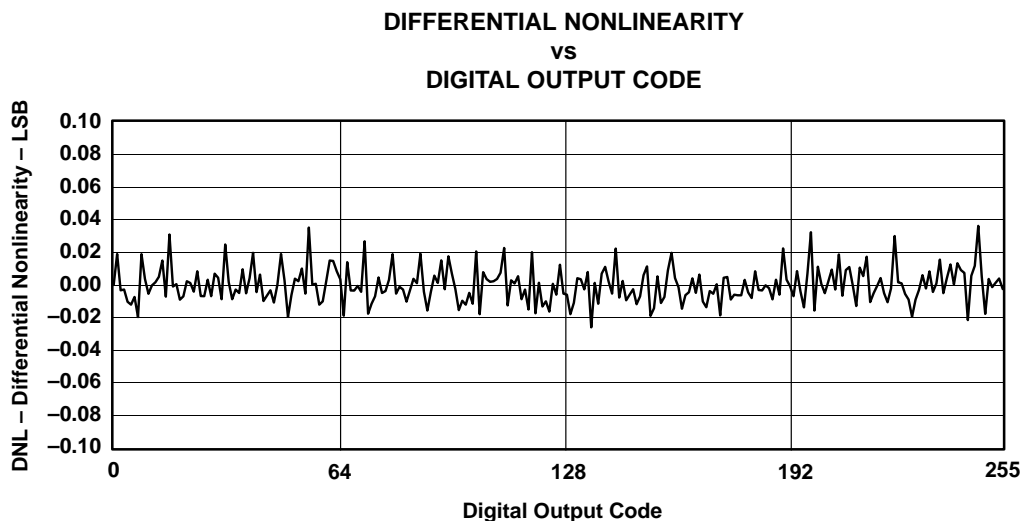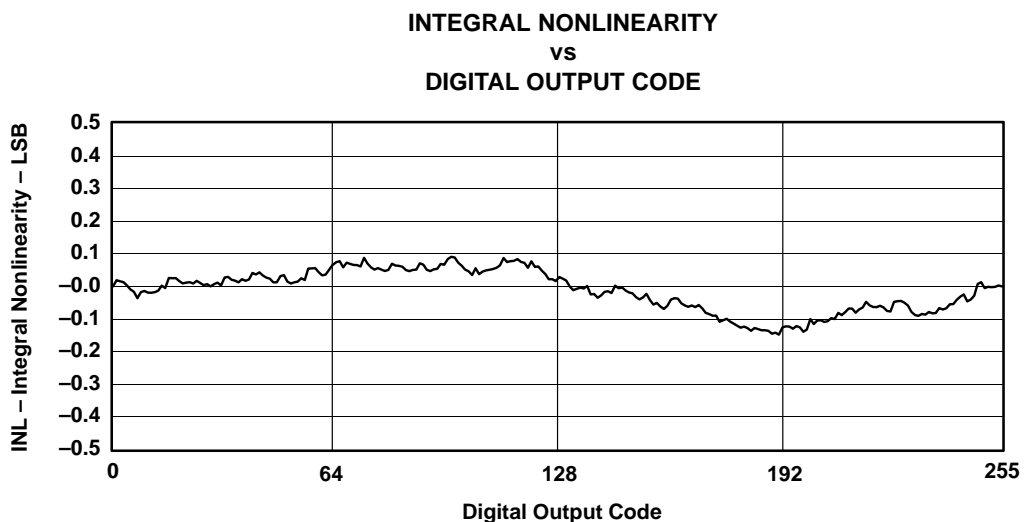**APPLICATION INFORMATION**

general function

The TLV5623 is an 8-bit single supply DAC based on a resistor string architecture. The device consists of a serial interface, speed and power-down control logic, a reference input buffer, a resistor string, and a rail-to-rail output buffer.

The output voltage (full scale determined by external reference) is given by:

$$2 \text{ REF } \frac{\text{CODE}}{2^n} \text{ [V]}$$

where REF is the reference voltage and CODE is the digital input value within the range of 0_{10} to 2^{n-1}, where n = 8 (bits). The 16-bit data word, consisting of control bits and the new DAC value, is illustrated in the *data format* section. A power-on reset initially resets the internal latches to a defined state (all bits zero).

serial interface

The device has to be enabled with $\overline{\text{CS}}$ set to low. A falling edge of FS starts shifting the data bit-per-bit (starting with the MSB) to the internal register on the falling edges of SCLK. After 16 bits have been transferred or FS rises, the content of the shift register is moved to the DAC latch, which updates the voltage output to the new level.

The serial interface of the TLV5623 can be used in two basic modes:

- Four wire (with chip select)
- Three wire (without chip select)

Using chip select (four-wire mode), it is possible to have more than one device connected to the serial port of the data source (DSP or microcontroller). The interface is compatible with the TMS320 family. Figure 15 shows an example with two TLV5623s connected directly to a TMS320 DSP.
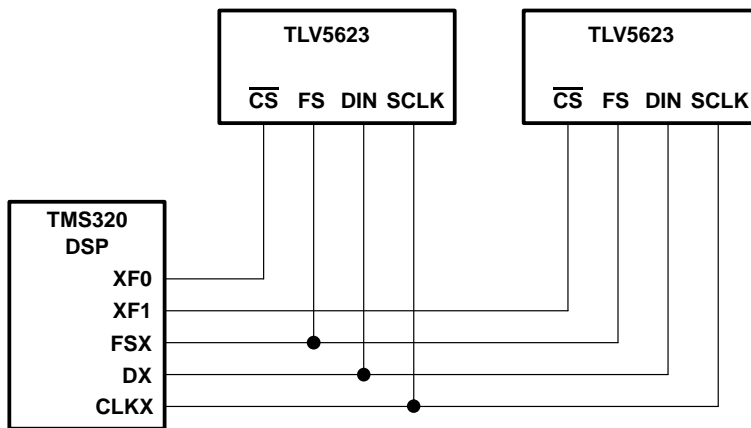

Figure 15. TMS320 Interface

APPLICATION INFORMATION

serial interface (continued)

If there is no need to have more than one device on the serial bus, then $\overline{CS}$ can be tied low. Figure 16 shows an example of how to connect the TLV5623 to a TMS320, SPI, or Microwire port using only three pins.
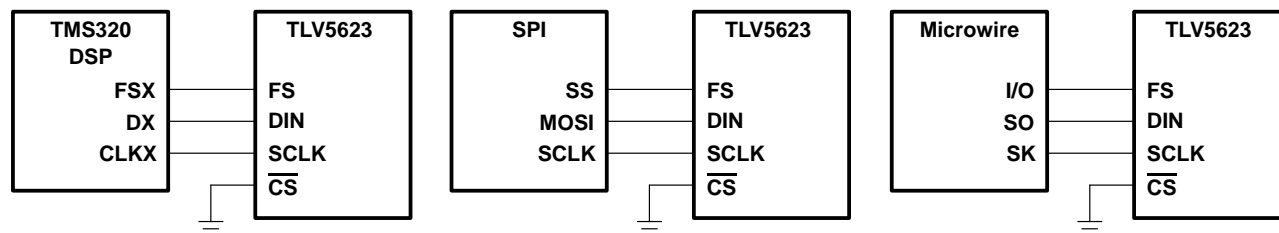

Figure 16. Three-Wire Interface

Notes on SPI and Microwire: Before the controller starts the data transfer, the software has to generate a falling edge on the I/O pin connected to FS. If the word width is 8 bits (SPI and Microwire), two write operations must be performed to program the TLV5623. After the write operation(s), the DAC output is updated automatically on the next positive clock edge following the sixteenth falling clock edge.

serial clock frequency and update rate

The maximum serial clock frequency is given by:

$$f_{SCLKmax} = \frac{1}{t_{wH(min)} + t_{wL(min)}} = 20 \text{ MHz}$$

The maximum update rate is:

$$f_{UPDATEmax} = \frac{1}{16 \left(t_{wH(min)} + t_{wL(min)} \right)} = 1.25 \text{ MHz}$$

The maximum update rate is a theoretical value for the serial interface, since the settling time of the TLV5623 has to be considered also.

data format

The 16-bit data word for the TLV5623 consists of two parts:

- Control bits   (D15 . . . D12)
- New DAC value   (D11 . . . D0)

D15	D14	D13	D12	D11	D10	D9	D8	D7	D6	D5	D4	D3	D2	D1	D0
X	SPD	PWR	X				New DAC value (8 bits)					0	0	0	0

X: don't care
SPD: Speed control bit.   1 → fast mode   0 → slow mode
PWR: Power control bit.   1 → power down   0 → normal operation

In power-down mode, all amplifiers within the TLV5623 are disabled.

APPLICATION INFORMATION

TLV5623 interfaced to TMS320C203 DSP

hardware interfacing

Figure 17 shows an example how to connect the TLV5623 to a TMS320C203 DSP. The serial interface of the TLV5623 is ideally suited to this configuration, using a maximum of four wires to make the necessary connections. In applications where only one synchronous serial peripheral is used, the interface can be simplified even further by pulling $\overline{CS}$ low all the time as shown in the figure.
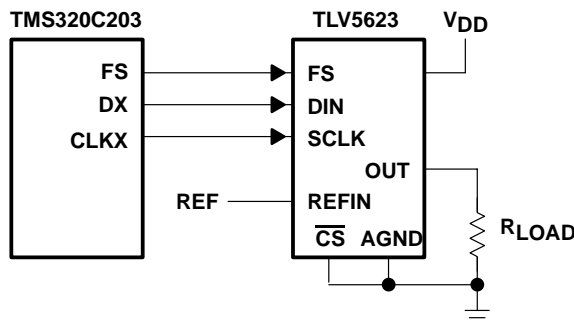
Figure 17. TLV5623 to DSP Interface

TLV5623 interfaced to MCS51® microcontroller

hardware interfacing

Figure 18 shows an example of how to connect the TLV5623 to an MCS51® compatible microcontroller. The serial DAC input data and external control signals are sent via I/O port 3 of the controller. The serial data is sent on the RxD line, with the serial clock output on the TxD line. P3.4 and P3.5 are configured as outputs to provide the chip select and frame sync signals for the TLV5623.
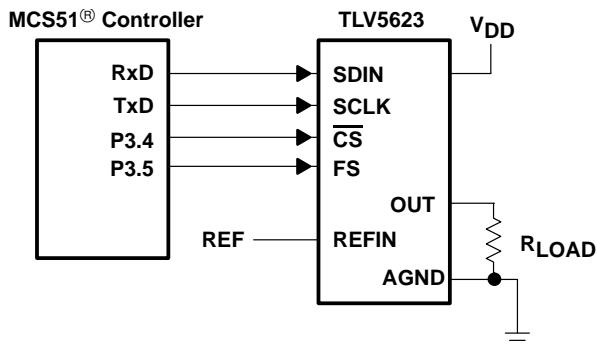
Figure 18. TLV5623 to MCS51® Controller Interface

MCS is a registered trademark of Intel Corporation

APPLICATION INFORMATION

linearity, offset, and gain error using single ended supplies

When an amplifier is operated from a single supply, the voltage offset can still be either positive or negative. With a positive offset, the output voltage changes on the first code change. With a negative offset, the output voltage may not change with the first code, depending on the magnitude of the offset voltage.

The output amplifier attempts to drive the output to a negative voltage. However, because the most negative supply rail is ground, the output cannot drive below ground and clamps the output at 0 V.

The output voltage then remains at zero until the input code value produces a sufficient positive output voltage to overcome the negative offset voltage, resulting in the transfer function shown in Figure 19.
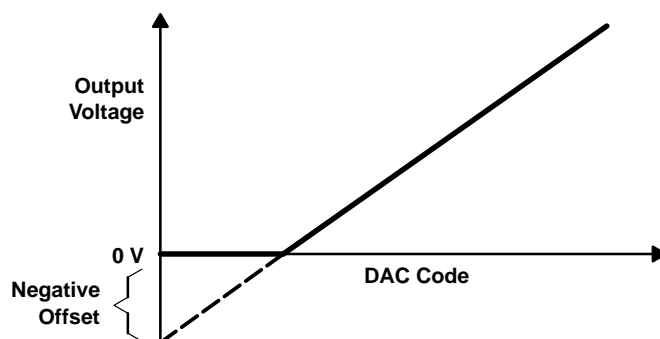

Figure 19. Effect of Negative Offset (single supply)

This offset error, not the linearity error, produces this breakpoint. The transfer function would have followed the dotted line if the output buffer could drive below the ground rail.

For a DAC, linearity is measured between zero-input code (all inputs 0) and full-scale code after offset and full scale are adjusted out or accounted for in some way. However, single supply operation does not allow for adjustment when the offset is negative due to the breakpoint in the transfer function. So the linearity is measured between full-scale code and the lowest code that produces a positive output voltage.

power-supply bypassing and ground management

Printed-circuit boards that use separate analog and digital ground planes offer the best system performance. Wire-wrap boards do not perform well and should not be used. The two ground planes should be connected together at the low-impedance power-supply source. The best ground connection may be achieved by connecting the DAC AGND terminal to the system analog ground plane, making sure that analog ground currents are well managed and there are negligible voltage drops across the ground plane.

A 0.1-μF ceramic-capacitor bypass should be connected between V_{DD} and AGND and mounted with short leads as close as possible to the device. Use of ferrite beads may further isolate the system analog supply from the digital power supply.

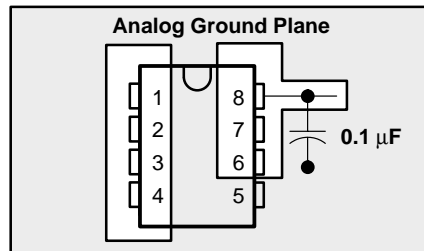Figure 20 shows the ground plane layout and bypassing technique.

Figure 20. Power-Supply Bypassing

![Texas Instruments logo]

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APPLICATION INFORMATION

definitions of specifications and terminology

integral nonlinearity (INL)

The relative accuracy or integral nonlinearity (INL), sometimes referred to as linearity error, is the maximum deviation of the output from the line between zero and full scale excluding the effects of zero code and full-scale errors.

differential nonlinearity (DNL)

The differential nonlinearity (DNL), sometimes referred to as differential error, is the difference between the measured and ideal 1 LSB amplitude change of any two adjacent codes. Monotonic means the output voltage changes in the same direction (or remains constant) as a change in the digital input code.

zero-scale error (E_{ZS})

Zero-scale error is defined as the deviation of the output from 0 V at a digital input value of 0.

gain error (E_G)

Gain error is the error in slope of the DAC transfer function.

signal-to-noise ratio + distortion (S/N+D)

S/N+D is the ratio of the rms value of the output signal to the rms sum of all other spectral components below the Nyquist frequency, including harmonics but excluding dc. The value for S/N+D is expressed in decibels.

spurious free dynamic range (SFDR)

SFDR is the difference between the rms value of the output signal and the rms value of the largest spurious signal within a specified bandwidth. The value for SFDR is expressed in decibels.

total harmonic distortion (THD)

THD is the ratio of the rms sum of the first six harmonic components to the rms value of the fundamental signal and is expressed in decibels.

MECHANICAL DATA

D (R-PDSO-G)**   **PLASTIC SMALL-OUTLINE PACKAGE**

14 PIN SHOWN

	PINS **	8	14	16
DIM				
A MAX		0.197 (5,00)	0.344 (8,75)	0.394 (10,00)
A MIN		0.189 (4,80)	0.337 (8,55)	0.386 (9,80)

4040047 / D 10/96
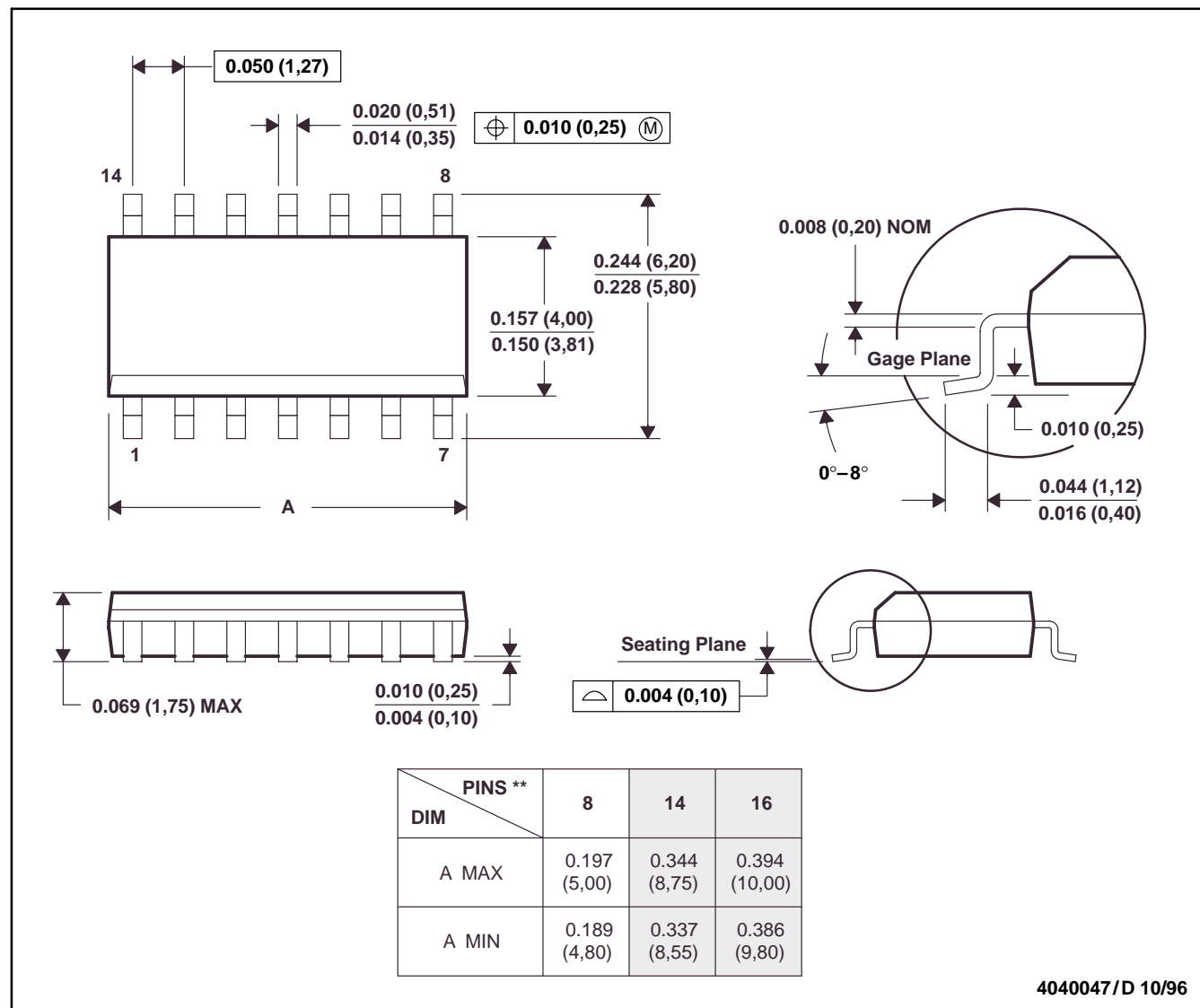
NOTES: A. All linear dimensions are in inches (millimeters).
        B. This drawing is subject to change without notice.
        C. Body dimensions do not include mold flash or protrusion, not to exceed 0.006 (0,15).
        D. Falls within JEDEC MS-012
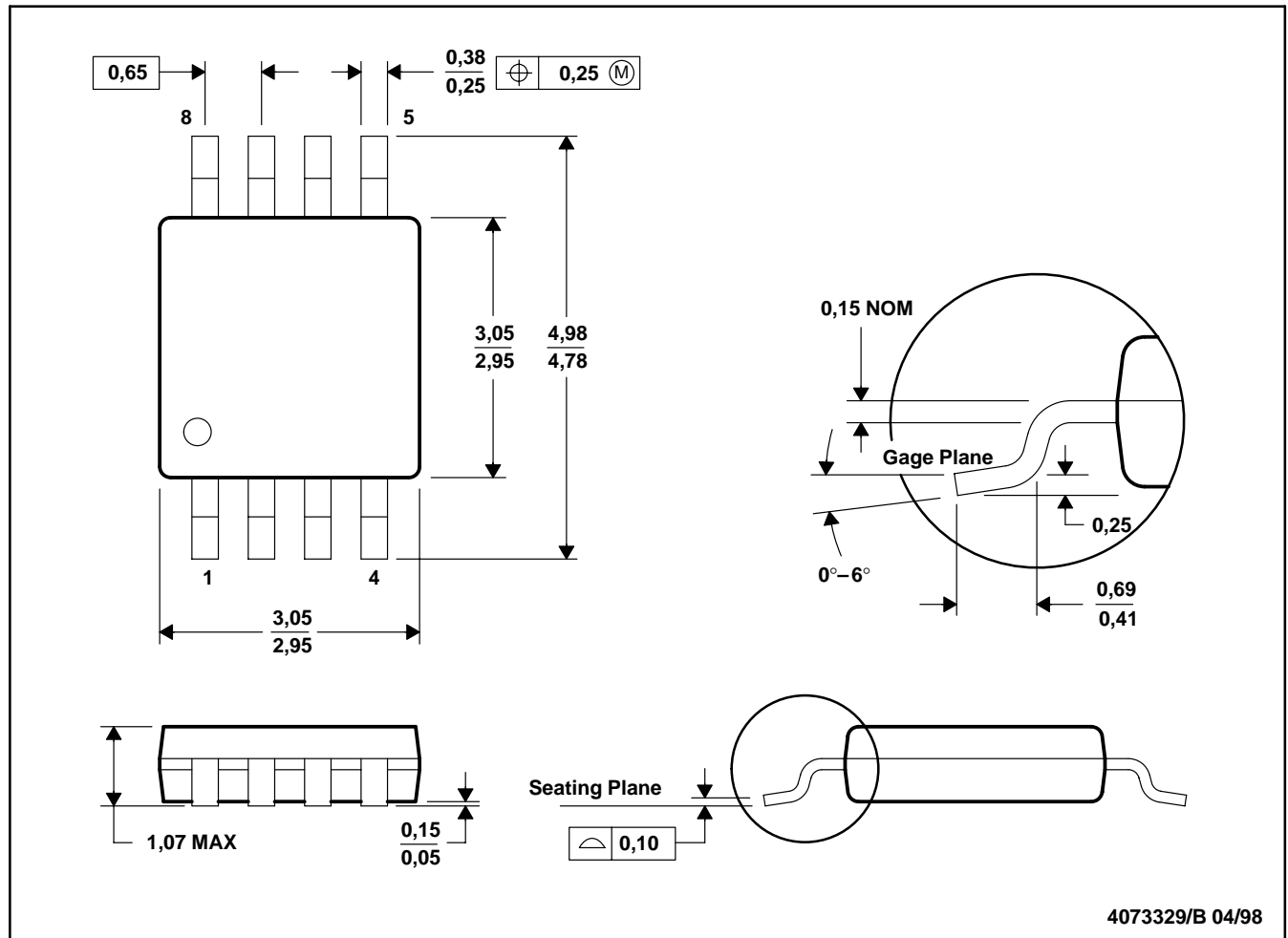
MECHANICAL DATA

DGK (R-PDSO-G8)   **PLASTIC SMALL-OUTLINE PACKAGE**

4073329/B 04/98

NOTES: A. All linear dimensions are in millimeters.
        B. This drawing is subject to change without notice.
        C. Body dimensions do not include mold flash or protrusion.
        D. Falls within JEDEC MO-187

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